MAX11312PMB# Peripheral Module

General Description

The MAX11312PMB# peripheral module (Pmod™) provides the necessary hardware to interface the MAX11312 12-channel programmable mixed-signal I/O device to any system that utilizes Pmod-compatible expansion ports configurable for I²C communication. The device is a 12-bit multichannel analog-to-digital converter (ADC) and a 12-bit buffered DAC output in a single IC. This device also includes software-configurable general-purpose I/O ports. A local and two remote temperature sensors keep track of junction and environmental temperatures. Adjacent pairs of ports can also be used as logic translator or analog switch. Each pin can also be used as a positive input of a comparator with programmable threshold.

Refer to the MAX11312 IC data sheet for detailed information regarding operation of the device and the USB2PMB2 (Munich) adapter board data sheet for detailed information regarding the Munich board and GUI. Refer to the MAX11312 peripheral module and Munich adaptor board *Quick Start Guide* for step-by-step evaluation instructions. Refer to the MAX11312 Configuration Software User Guide for detailed information using the design tool.

Features

- Up to 12 12-Bit ADC Programmable Inputs
- Up to 12 12-Bit DACs with 25mA Current Capability
 - 70mA max at +12V with On-Board Power Supply

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- 30mA (typ) at -12V with On-Board Power Supply
- Use External Power Supply at VDDIO (VDDIO Jumper Removed) if More Current is Needed
- Up to 12 Digital I/Os
- Up to 12 Comparator Inputs
- Internal or External Reference for ADC and DAC
- Individually Selectable ADC References for Each Port
- Internal Temperature Sensor (-40°C to +125°C, ±3°C Accuracy)
- Two Remote Temperature-Measurement Controllers (-40°C to +150°C, ±3°C Accuracy)
- 2 x 6-Pin Pmod-Compatible Connector (I²C)
- RoHS Compliant
- Proven PCB Layout
- Fully Assembled and Tested

Ordering Information appears at end of data sheet.

Peripheral Module Board Photo



Pmod is a trademark of Digilent Inc.

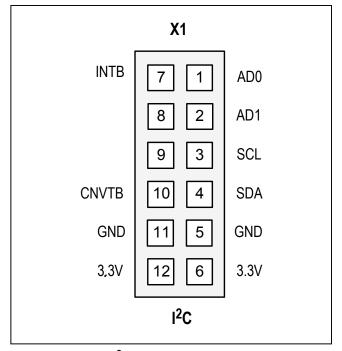


Detailed Description

I2C Interface

The MAX11312PMB# Pmod can plug directly into a Pmod-compatible port (configured for I²C) through the X1 connector. For information on the I²C protocol, refer to the MAX11312 IC data sheet.

- Connector X1 provides connection of the module to the Pmod host. See <u>Table 1</u> and <u>Figure 1</u> for detailed description.
- Connector JP1 provides selection of +3.3V either from the PMOD_SUPPLY or an external supply (X2).
- Connectors SV1 and SV2 provide connection to the IC pins (MAX11312 ports 0–11). Connector SV3 is ground.
- Connectors EXT_TEMP1 and EXT_TEMP2 provide connection to the external temperature sensors.
- Connector VDDIO provides connection to the AVDDIO pins of the device, which is connected to the +12V power supply
- Connector VSSIO provides connection to the AVSSIO pins of the device, which is the analog negative supply for mixed-signal ports. Install the VSSIO jumper from 1 to 2 to connect AVSSIO to ground. Install VSSIO from 2 to 3 to connect AVSSIO to -12V.



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Figure 1. X1: Pmod I²C Connector Pin Configuration

Table 1. Connector X1 (I²C Communication)

PIN	SIGNAL	DESCRIPTION						
1	AD0	MAX11312 Slave Address Bit 0						
2	AD1	MAX11312 Slave Address Bit 1						
3	SCL	MAX11312 Serial Interface Clock Input						
4	SDA	MAX11312 Serial Interface Input and Output						
5, 11	GND	Ground						
6, 12	+3.3V	+3.3V Power Supplies						
7	INTB	Interrupt Open-Drain Output. Asserted low when the MAX11312 issues an interrupt.						
8	_	No Connection						
9	_	No Connection						
10	CNVTB	ADC Conversion Control Input. Assert low to initiate an ADC conversion.						

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Default Jumper Setting

Verify that all jumpers are in their default positions, as follows:

- 1) Jumper VDDIO: Connect from VDDIO to +12V.
- 2) Jumper VSSIO: Connect from VSSIO to GND.
- 3) Jumpers EXT_TEMP1 and EXT_TEMP2: Open.
- 4) Jumper JP1: Connect PMOD_SUPPLY to +3.3V, JP1-1 to JP1-2.

Power Supplies

The Pmod contains the MAX8752 step-up DC-DC converter (U3), which upconverts the +3.3V power supply from the Pmod X1 connector to +13V. The MAX5084 (U2) linear regulator then regulates the +13V input to +5V output voltage, providing power supply to the positive analog supply AVDD of the IC. Another MAX5084 (U1) provides a +12V power supply to the positive analog supply of the mixed-signal ports (AVDDIO) of the IC. In addition, the MAX629 (U5) provides -12V power supply to the VSSIO from +3.3V input. For bipolar applications, use an external power supply to provide negative voltage for AVSSIO. See Figure 2.

Software Graphical User Interface (GUI)

The Munich software GUI is provided to facilitate evaluation of the Pmod.

Visit www.maximintegrated.com/evkitsoftware to download the latest version of the Munich GUI software. Refer to the MAX11312PMB# peripheral module and Munich (USB2PMB2) adapter board *Quick Start Guide* for step-by-step evaluation using the Munich GUI.

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External Power Supply

The on-board power supply provides 70mA max current at VDDIO = +12V. If additional current is needed, use an external power supply by removing the jumper connecting VDDIO to +12V and connecting a +12V external power supply to the VDDIO pin.

For bipolar applications, remove the jumper from VSSIO pin to GND and connect it from pin 2 to pin 3. See Figure 2 and refer to the MAX11312 IC data sheet for details.

External Temperature Sensors

Two-pin connector vertical headers, EXT_TEMP1 and EXT_TEMP2, are provided to measure the environment temperature. Connect the base and collector of diodeconnected transistors, such as the 2N3906 to the TEMP1 or TEMP2 pin and the emitter to the EXT pin to measure the external temperature. See Figures 3 and 4.

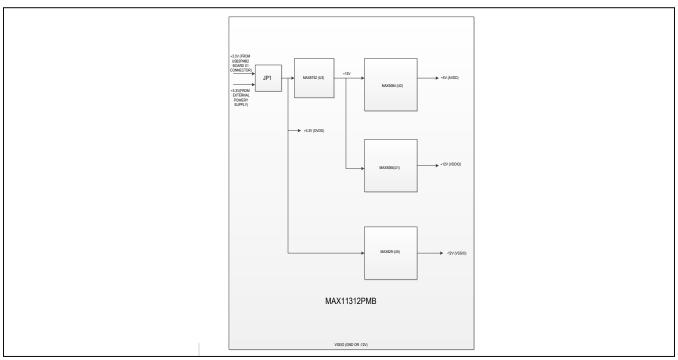
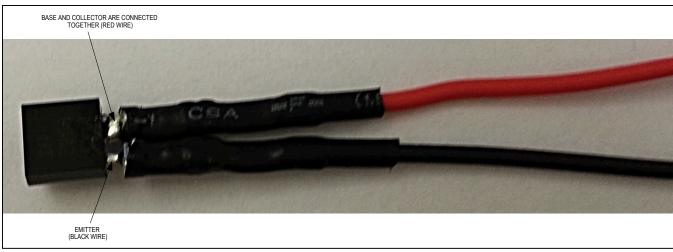


Figure 2. Power-Supply Block Diagram



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Figure 3. 2N3906 Diode-Connected Transistor Assembly (Not Included)



Figure 4. External Temperature Sensor Using Diode-Connected Transistor (Not Included)

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Component Suppliers

SUPPLIER	WEBSITE
Pulse Electronics	www.pulseelectronics.com
TDK Corp.	www.component.tdk.com
TE Connectivity	www.te.com

Note: Indicate that you are using the MAX11312PMB# when contacting these component suppliers.

Component List, PCB Files, and Schematics

See the following links for component information, PCB layout diagrams, and schematic.

- MAX11312PMB# EV BOM
- MAX11312PMB# EV PCB Layout
- MAX11312PMB# EV Schematic

Ordering Information

PART	TYPE
MAX11312PMB#	Peripheral Module
USB2PMB2#	Munich Adapter Board
MAX11312SYS1#	Peripheral Module and Munich Adapter Board

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#Denotes RoHS compliant.

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Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	2/16	Initial release	_

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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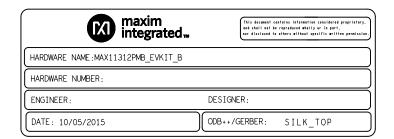
TITLE: Bill of Materials DATE: 10/05/2015

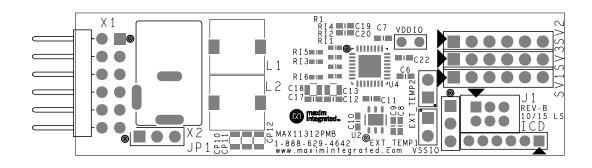
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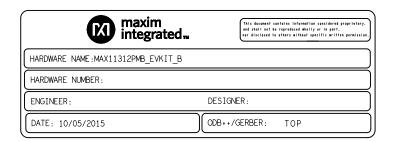
ITEM	REF_DES	DNI/DNP	QTY	MFG PART #	MANUFACTURER	VALUE	DESCRIPTION
							CAPACITOR; SMT (0603); CERAMIC CHIP; 10UF;
							10V; TOL=10%; MODEL=; TG=-55 DEGC TO +85
1	C1, C2, C5, C15, C24	-	5	C1608X5R1A106K	TDK	10UF	DEGC; TC=X5R
				CDN4400D74E40EVA			CARACITOR, CART (OCO3), CERANAIC CHIR. 1115.
				GRM188R71E105KA			CAPACITOR; SMT (0603); CERAMIC CHIP; 1UF;
,	62 67 69 611 614 620		_	12D;	MURATA	4115	25V; TOL=10%; MODEL=GRM SERIES; TG=-55
	C3, C7, C8, C11, C14, C20	-	Ь	CGA3E1X7R1E105K C0603C104K4RAC;	MUKATA	1UF	DEGC TO +125 DEGC; TC=X7R
				GCM188R71C104KA			
				37;			
				C1608X7R1C104K;			
	C4, C6, C9, C10, C12, C16, C17,			GRM188R71C104K;			CAPACITOR; SMT (0603); CERAMIC CHIP; 0.1UF;
	C19, C21-C23, C25, C27, C28,				KEMET/MURATA/TDK/V		16V; TOL=10%; TG=-55 DEGC TO +125 DEGC;
3	CP2, CP8, CP9, CP13	_	18	104KNE	ENKEL LTD.	0.1UF	TC=X7R;
	1		10	10 111112	ETTALE ET D.	0.101	CAPACITOR; SMT (0805); CERAMIC CHIP; 4.7UF;
							25V; TOL=10%; MODEL=X5R; TG=-55 DEGC TO
4	C13, C18	-	2	GRM21BR61E475KA	MURATA	4.7UF	+125 DEGC; TC=+/
	,						CAPACITOR; SMT (0805); CERAMIC CHIP; 10UF;
				ECJ-2FF1A106Z;	PANASONIC/YAGEO		10V; TOL=+80%-20%; MODEL=Y5V; TG= -30
5	CP1, CP5, CP10-CP12	-	5	CC0805ZKY5V6BB1	PHYCOMP	10UF	DEGC TO +85 DEGC; T;
							CAPACITOR; SMT (0603); CERAMIC CHIP; 2.2UF;
				C1608X5R1E225K;			25V; TOL=10%; MODEL=; TG=-55 DEGC TO +85
6	CP3	-	1	TMK107ABJ225KA-T	TDK/TAIYO YUDEN	2.2UF	DEGC; TC=X5R
				C0603C224K3RAC;			
				GMC10X7R224K25;			CARACITOR CAST (OCCO), OFRANCIO CIUR
				GRM188R71E224KA			CAPACITOR; SMT (0603); CERAMIC CHIP;
_				88;			0.22UF; 25V; TOL=10%; TG=-55 DEGC TO +125
7	CP4	-	1	C1608X/R1E224K08	KEMET; MURATA; TDK	0.22UF	DEGC; TC=X7R
				C0603HON101			CAPACITOR; SMT; 0603; CERAMIC; 20pF; 100V;
,	CDC		4	C0603HQN101-	VENIZEL LTD	2005	5%; COG; -55degC to + 125degC; 0 +/-
8	CP6	-	1	200JNP	VENKEL LTD.	20PF	30PPM/degC CAPACITOR; SMT; 0603; CERAMIC; 1200pF;
				C0603C0G500-			50V; 10%; COG; -55degC to + 125degC; 0 +/-
_	CP7		1	122KNP	VENKEL LTD	1200PF	30PPM/degC
9	CF/	<u> </u>	1	TZZKINY	VENKEL LTD.	120025	SUPPIVI/ GERC

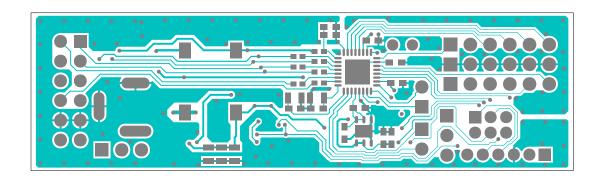
							CAPACITOR; SMT (0805); CERAMIC CHIP; 2.2UF;
							50V; TOL=10%; MODEL=; TG=-55 DEGC TO +125
10	CP14	-	1	C2012X7R1H225K	TDK	2.2UF	DEGC; TC=X7R
							CAPACITOR; SMT (0603); CERAMIC CHIP; 150PF;
						1	100V; TOL=10%; MODEL=COG; TG=-55 DEGC TO
11	CP15	-	1	C0603C151K1GAC	KEMET	150PF	+125 DEGC; TC=+
						CRS10I30	
12	D1	-	1	CRS10I30A	TOSHIBA	Α	DIODE; SCH; SMT (SOD-123F); PIV=30V; IF=1A
							DIODE; SCH; SURFACE MOUNT SCHOTTKY
13	D2, D3	-	2	MBRS540T3G	ON SEMICONDUCTOR	Т3	POWER RECTIFIER; SMC; PIV=40V; IF=5A
							CONNECTOR; MALE; THROUGH HOLE;
14	EXT_TEMP1, EXT_TEMP2	-	2	PEC02SAAN	SULLINS	N	BREAKAWAY; STRAIGHT; 2PINS
							CONNECTOR; MALE; THROUGH HOLE; 2MM
						M22-	PITCH; SIL VERTICAL PIN HEADER ASSEMBLY;
15	ICD	-	1	M22-2510605	HARWIN	2510605	STRAIGHT; 6PINS
							CONNECTOR; MALE; THROUGH HOLE; DF11
					HIROSE ELECTRIC CO		SERIES; DOUBLE-ROW CONNECTOR; STRAIGHT;
16	J1	=	1	DF11-6DP-2DSA(24)	LTD		6PINS
						PEC03SAA	CONNECTOR; MALE; THROUGH HOLE;
17	JP1, VSSIO	=	2	PEC03SAAN	SULLINS	N	BREAKAWAY; STRAIGHT; 3PINS
							INDUCTOR; SMT; FERRITE CORE; 3.3UH; TOL=+/-
18	L1	-	1	DR74-3R3-R	COILTRONICS	3.3UH	20%; 3.94A
							INDUCTOR; SMT; FERRITE CORE; 47UH; TOL=+/-
19	L2	-	1	DR74-470-R	COILTRONICS	47UH	20%; 1.15A
				RG1005P-101-B-T5;	SUSUMU CO		RESISTOR, 0402, 100 OHM, 0.1%, 25PPM,
20	R1, R4	-	2	ERA-2AEB101X	LTD./PANASONIC	100	0.0625W, THICK FILM
				CRCW0402100KFK;	VISHAY DALE; YAGEO		RESISTOR; 0402; 100K; 1%; 100PPM; 0.0625W;
21	R2, R5, R8	-	3	RC0402FR-07100KL	PHICOMP	100K	THICK FILM
							RESISTOR, 0402, 12K OHM, 1%, 100PPM,
22	R3	-	1	CRCW040212K0FK	VISHAY DALE	12K	0.0625W, THICK FILM
				CRCW040210K0FK;	VISHAY DALE; YAGEO		RESISTOR; 0402; 10K; 1%; 100PPM; 0.0625W;
23	R6, R9, R11-R15	-	7	RC0402FR-0710K	PHICOMP	10K	THICK FILM
							RESISTOR; 0402; 40.2K OHM; 1%; 100PPM;
24	R7	-	1	CRCW040240K2FK	VISHAY DALE	40.2K	0.063W; THICK FILM
							RESISTOR, 0805, 2 OHM, 1%, 100PPM, 0.125W,
25	R10	-	1	CRCW08052R00FN	VISHAY DALE	2	THICK FILM
						1	RESISTOR; 0402; 0 OHM; 0%; JUMPER; 0.063W;
26	RG	-	1	CRCW04020000ZS	VISHAY DALE	0	THICK FILM

			I		1		
				RC0402JR-070RL;	YAGEO		RESISTOR; 0402; 0 OHM; 5%; JUMPER; 0.063W;
27	RI1-RI6	_		,	PHYCOMP/VENKEL LTD.	0	THICK FILM
	MI MO		- 0	CN0402 10W 000N31	TITICOIVII / VEINKEE ETD.	0	THERTEIN
						22-28-	CONNECTOR; MALE; THROUGH HOLE; FLAT
28	SV1-SV3	_	3	22-28-4063	MOLEX	4063	VERTICAL BREAKAWAY; STRAIGHT; 6PINS
	341 343			22 20 4003	WOLLX		IC; VREG; LOW-QUIESCENT-CURRENT LINEAR
20	U1,U2		2	MAX5084ATT+T	MAXIM	ATT+T	REGULATOR; TDFN6
23	01,02	-		IVIAA3U04ATT+T	IVIAAIIVI	MAX8752	IC; CONV; TFT LCD STEP-UP DC-DC CONVERTER;
20	U3		4	MAX8752ETA+	MAXIM	ETA+	TDFN8-EP
30	03		1	IVIAX8/3ZETA+	IVIAAIIVI	ETA+	1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 -
						B 4 6 3/4 4 2 4	EVKIT PART-IC; MAX11311; PACKAGE OUTLINE:
						MAX1131	21-0140; PACKAGE CODE: T3255-4; TQFN32-EP;
31	U4	-	1	MAX11311	MAXIM	1	NO FINAL DATASHEET
							IC; CONV; LOW-POWER HIGH-VOLTAGE BOOST
							OR INVERTING DC-DC CONVERTER; NSOIC8
32	U5	-	1	MAX629ESA+	MAXIM	SA+	150MIL
							IC; CTRL; ATMEL 8-BIT AVR MICROCONTROLLER
						ATTINY25-	WITH 2K BYTES IN-SYSTEM PROGRAMMABLE
33	U7	-	1	ATTINY25-20SU	ATMEL	20SU	FLASH; WSOIC8
						923345-	CONNECTOR; MALE; THROUGH HOLE; JUMPER
34	VDDIO	-	1	923345-01-C	?	01-C	WIRE; STRAIGHT; 2PINS
						TSW-106-	CONNECTOR; THROUGH HOLE; POST TERMINAL
35	X1	-	1	TSW-106-08-S-D-RA	SAMTEC		STRIP ASSEMBLY; RIGHT ANGLE; 12PINS;
					<u> </u>	KLDX-	CONNECTOR; FEMALE; THROUGH HOLE; DC
36	X2	_	1	KLDX-0202-B	KYCON	0202-B	POWER JACK; RIGHT ANGLE; 3PINS
- 30	,, <u> </u>					0202 5	RESISTOR; 0402; 1K OHM; 0.5%; 25PPM;
27	RU1, RU2	DNP	2	RG1005P-102-D	SUSUMU CO LTD.	1K	0.0625W; THIN FILM
- 37	NO1, NO2	DIAL		NG10031 102-D	JOJOIVIO CO LID.	±1/	O.OOZOVV, TITTIVI I LIVI
						DIC10E200	IC; CTRL; 6-PIN; 8-BIT FLASH
20	116	DNP	4	DIC10E200 I/OTC	MICDOCHID		, , , ,
38	U6	אוט	1	PIC10F200-I/OTG	MICROCHIP	I/OTG	MICROCONTROLLER; SOT23-6

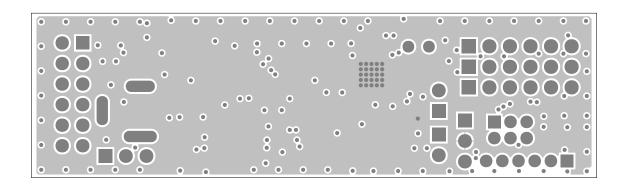


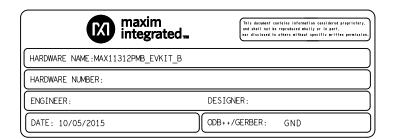


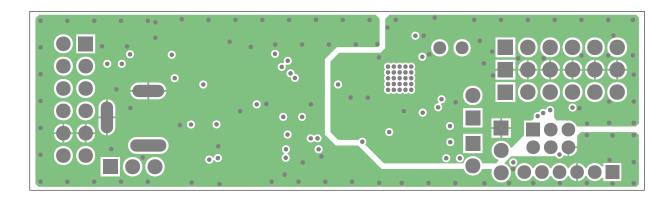




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HARDWARE NAME:MAX11312PMB_EVKIT_B	
HARDWARE NUMBER:	
ENGINEER:	DESIGNER:
DATE: 10/05/2015	ODB++/GERBER: VSS_IO







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ENGINEER:	DESIGNER:
DATE: 10/05/2015	ODB++/GERBER: BOTTOM

